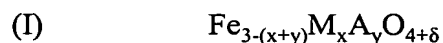


**Amendments to the Claims:**

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A method of ~~The use as a sensitive material in a thin layer for~~ bolometric detection of infrared radiation, comprising:

detecting the infrared radiation by using a sensitive material in a thin layer, the of a material having a spinel ferrite structure of chemical composition, ignoring doping agents if any are present, satisfying empirical formula I:



in which iron is the majority metallic element;

M presents a metal or a combination of two or more transition metals other than iron;

A represents at least one metal selected from magnesium and aluminum;

the metals and the oxygen being in the form of ions;

$x$  represents the number of metal ions M, whether identical or different metals;

$y$  represents the number of metal ions A;

$x$  may lie in the range 0 to 2, and whatever  $x$ ,  $x < 3-x-y$ ,

$y$  may lie in the range 0 to 0.5; and

$\delta$  represents 0 or a positive number that is sufficiently small for the substance of formula I to contain at least one metal present in the form of ions having two different oxidation states and situated on the same sublattice of the spinel structure.

2. (Currently Amended) The method ~~A use~~ according to claim 1, in which M is a metal selected from Co, Cu, Mn, Zn, Ni, V, Cr, Mo, W, Ti, Zr, Hf, and rare earths, presenting an ionic radius compatible with being integrated in the spinel structure, or a combination thereof.

3. (Currently Amended) The method A-use according to claim 1 ~~either preceding claim,~~  
in which M represents a metal selected from Co, Cu, Mn, Ni, Zn, and Ti, or a combination thereof.
4. (Original) A bolometric device for detecting infrared radiation or for infrared imaging, the device comprising at least one sensor provided with a sensitive element in the form of a thin layer as defined in any preceding claim.
5. (Original) A bolometric device according to claim 4, in which said sensor, inserted in a packet including an inlet window that is transparent to infrared, comprises a membrane capable of absorbing infrared radiation and of converting it into heat, said membrane being disposed in such a manner as to be capable of being exposed to incident infrared radiation that has passed through the inlet window, and in such a manner as to transmit a fraction of the heat produced in this way to said sensitive element.
6. (Currently Amended) A device according to claim 4 ~~or claim 5~~, comprising a plurality of said sensors in the form of an array of pixels.
7. (Original) A device according to claim 6, in which said array is connected to a CCD or CMOS matrix.
8. (Currently Amended) A method of detecting infrared radiation or of producing infrared imaging with the help of a bolometric device capable of absorbing incident radiation, of converting it into heat, and of communicating a fraction of the heat produced to a sensitive

element of resistivity that varies with temperature, in which said device is a device as defined in claim 4 ~~any one of claims 4 to 7~~.

9. (New) The method according to claim 2, in which M represents a metal selected from Co, Cu, Mn, Ni, Zn, and Ti, or a combination thereof.

10. (New) A device according to claim 5, comprising a plurality of said sensors in the form of an array of pixels.

11. (New) A device according to claim 10, in which said array is connected to a CCD or CMOS matrix.

12. (New) A method of detecting infrared radiation or of producing infrared imaging with the help of a bolometric device capable of absorbing incident radiation, of converting it into heat, and of communicating a fraction of the heat produced to a sensitive element of resistivity that varies with temperature, in which said device is a device as defined in claim 5.

13. (New) A method of detecting infrared radiation or of producing infrared imaging with the help of a bolometric device capable of absorbing incident radiation, of converting it into heat, and of communicating a fraction of the heat produced to a sensitive element of resistivity that varies with temperature, in which said device is a device as defined in claim 6.

14. (New) A method of detecting infrared radiation or of producing infrared imaging with the help of a bolometric device capable of absorbing incident radiation, of converting it into heat,

and of communicating a fraction of the heat produced to a sensitive element of resistivity that varies with temperature, in which said device is a device as defined in claim 10.

15. (New) A method of detecting infrared radiation or of producing infrared imaging with the help of a bolometric device capable of absorbing incident radiation, of converting it into heat, and of communicating a fraction of the heat produced to a sensitive element of resistivity that varies with temperature, in which said device is a device as defined in claim 7.

16. (New) A method of detecting infrared radiation or of producing infrared imaging with the help of a bolometric device capable of absorbing incident radiation, of converting it into heat, and of communicating a fraction of the heat produced to a sensitive element of resistivity that varies with temperature, in which said device is a device as defined in claim 11.